Hex Non-Inverting Buffer

General Description

The ET74AHC34 is a high-performance hex non-inverting buffer gate operating from a 2.0V to 5.5V supply. This device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive.

Features

- Designed for 2V to 5.5V V_{CC} Operation
- Over-voltage Tolerant Inputs Accept Voltages to 5.5V
- ±5.2mA Balanced Output Sink and Source Capability
- CMOS Low-Power Consumption and High Noise Immunity
- I_{OFF} Supports Partial-Power-Down Mode Operation
- ESD Protection Complies with JESD22 Standard
  -- HBM: ±4000V Pass (JEDEC JS-001)
  -- CDM: ±1000V Pass (JEDEC JS-002)
- Latch-up Performance Exceeds ±100mA Per JEDEC JESD78F
- Part No. and Package Information

Part No.	Package	MSL
ET74AHC34M	SOP14 (3.9mm × 8.65mm)	3
ET74AHC34V	TSSOP14 (4.4mm × 5.0mm)	3

Pin Configuration

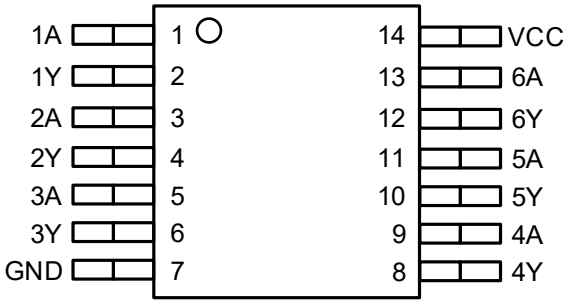


Figure1. Pin Configuration

Pin Function

SOP14/TSSOP14

Pin No.	Pin Name	Function
1	1A	Channel 1, Input A
2	1Y	Channel 1, Output Y
3	2A	Channel 2, Input A
4	2Y	Channel 2, Output Y
5	3A	Channel 3, Input A
6	3Y	Channel 3, Output Y
7	GND	Ground
8	4Y	Channel 4, Output Y
9	4A	Channel 4, Input A
10	5Y	Channel 5, Output Y
11	5A	Channel 5, Input A
12	6Y	Channel 6, Output Y
13	6A	Channel 6, Input A
14	VCC	Supply Voltage

Block Diagram

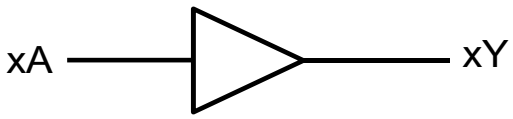


Figure2. Logic Symbol

Functional Table

Input	Output
xA	**xY**
L	L
H	H

Absolute Maximum Ratings

Symbol	Parameter		Value	Unit
V_{CC}	DC Supply Voltage (VCC Pin)		-0.5 to 7.0	V
V_I	DC Input Voltage (1)		$-0.5 \le V_I \le 7.0$	V
I_{IK}	DC Input Diode Current, V_I < GND		±20	mA
I_{OK}	DC Output Diode Current, V_O < GND, V_O > V_{CC}		±20	mA
I_O	DC Output Sink Current		±25	mA
I_{CC}	DC Supply Current per Supply Pin		50	mA
I_{GND}	DC Supply Current GND Pin		-50	mA
T_{STG}	Storage Temperature Range		-65 to 150	°C
V_{ESD}	ESD Classification	Human Body Model (2)	±4000	V
		Charged Device Model (3)	±1000	
I_{LU}	Max Latch Up Current Above V_{CC} and GND at 125°C (4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Note1: I_O absolute maximum rating must be observed.

Note2: HBM tested per JEDEC JS-001;

Note3: CDM tested per JEDEC JS-002;

Note4: Latch up Current Maximum Rating tested per JEDEC JESD78F.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage Operating	2	5.5	V
V_I	DC Input Voltage	0	V_{CC}	V
V_O	DC Output Voltage (High or Low State)	0	V_{CC}	V
T_A	Operating Temperature Range	-40	125	°C

Electrical Characteristics

DC Electrical Characteristics

Symbol	Parameter	Condition	V_{CC}(V)	T_A = 25°C			-40°C ≤ T_A ≤ 125°C		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	High-Level Input Voltage		2.0	1.5			1.5		V
			3.0	2.1			2.1		
			5.5	3.85			3.85		
V_{IL}	Low-Level Input Voltage		2.0			0.5		0.5	V
			3.0			0.9		0.9	
			5.5			1.65		1.65	
V_{OH}	High-Level Output Voltage	I_{OH} = -50uA	2~5.5	V_{CC} - 0.1	V_{CC}		V_{CC} - 0.1		V
		I_{OH} = -4mA	3	2.58			2.4		
		I_{OH} = -8mA	4.5	3.54			3.7		
V_{OL}	Low-Level Output Voltage	I_{OL} = 50uA	2~5.5			0.1		0.1	V
		I_{OL} = 4mA	3			0.36		0.55	
		I_{OL} = 8mA	4.5			0.36		0.55	
I_I	Input Leakage Current	V_I = 5.5V or GND	0~5.5			0.1		2.0	uA
I_{CC}	Quiescent Supply Current	V_I = 5.5V or GND	5.5			1		40	uA

AC Electrical Characteristics

$t_r = t_f$ = 3ns;

Symbol	Parameter	Condition	V_{CC}(V)	T_A = 25°C			-40°C ≤ T_A ≤ 125°C		Unit
				Min	Typ	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay (Figure3 and 4)	C_L = 15pF	3~3.6		7.4	10.9	1	13.4	ns
		C_L = 50pF	3~3.6		9.4	15.9	1	18.9	
		C_L = 15pF	4.5~5.5		5.9	7.9	1	9.4	
		C_L = 50pF	4.5~5.5		7	9.9	1	11.9	

Capacitance Characteristics

Symbol	Parameter	Condition	Typ	Unit
C_{IN}	Input Capacitance	V_{CC} = 5.5V, V_I = 0V or V_{CC}	2.5	pF
C_{PD}	Power Dissipation Capacitance (5)	10MHz, V_{CC} = 3.3V, V_I = 0V or V_{CC}	21	pF
		10MHz, V_{CC} = 5.5V, V_I = 0V or V_{CC}	21	

Note5: C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

AC Test Circuit

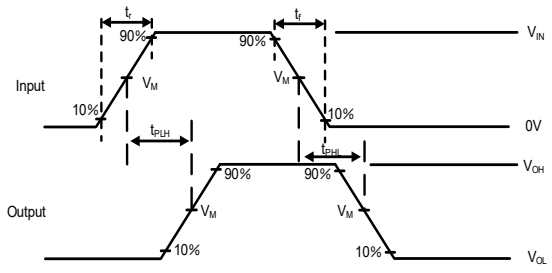


Figure3. Switching Waveform

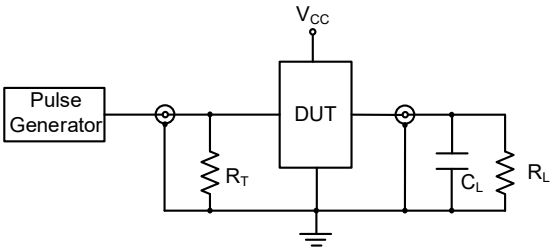
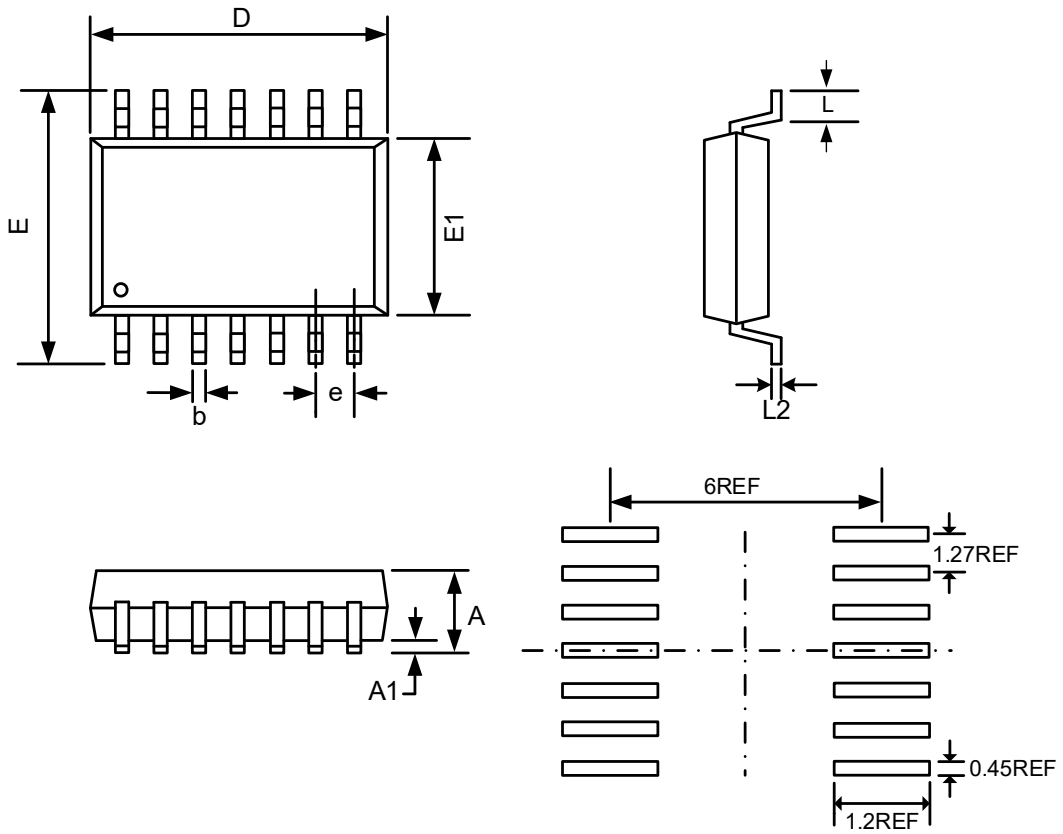


Figure4. Test Circuit

Package Dimension

SOP14 (3.9mm × 8.65mm)

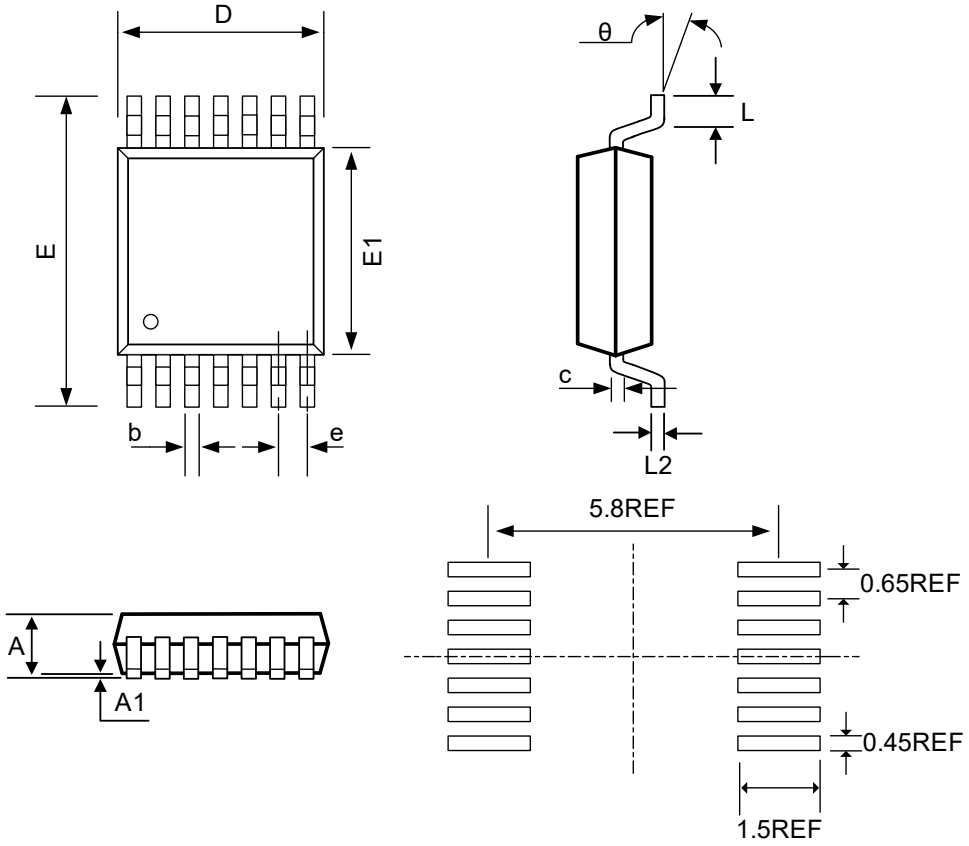


COMMON DIMENSIONS

(Unit: mm)

SYMBOL	MIN	MAX
A	--	1.75
A1	0.10	0.25
b	0.36	0.51
D	8.55	8.75
E	5.80	6.20
E1	3.80	4.00
e	1.22	1.32
L	0.45	0.75
L2	0.25 BSC	

TSSOP14 (4.4mm × 5.0mm)



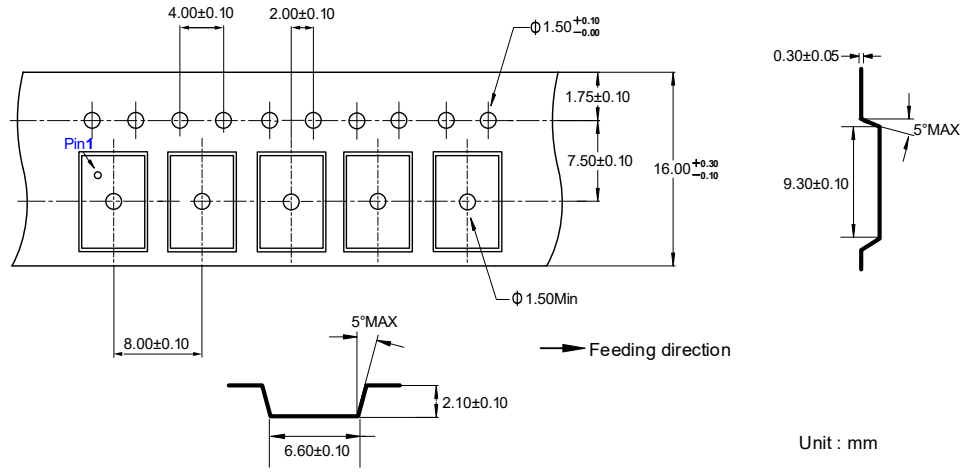
COMMON DIMENSIONS

(Unit: mm)

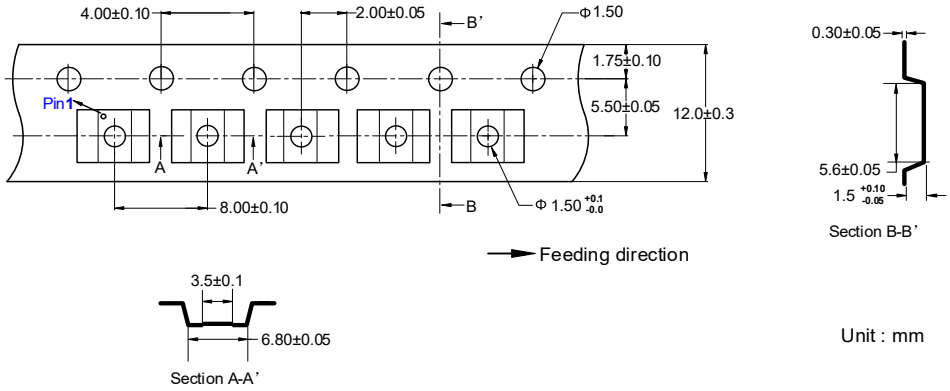
SYMBOL	MIN	MAX
A	--	1.20
A1	0.05	0.15
b	0.19	0.30
c	0.15 REF	
D	4.86	5.10
E	6.20	6.60
E1	4.30	4.50
e	0.65BSC	
L	0.45	0.75
L2	0.25 REF	
θ	0°	8°

Tape Information

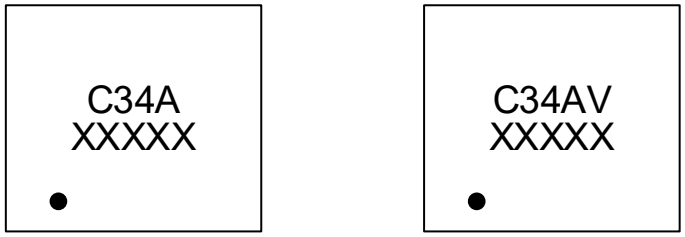
SOP14 (3.9mm × 8.65mm)



TSSOP14 (4.4mm × 5.0mm)



Marking Information



ET74AHC34M
C34A = Part Number
XXXXX = Tracking Number

ET74AHC34V
C34AV = Part Number
XXXXX = Tracking Number

Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
1.0	2026-03-24	Official Version	Xu tao	Yang xiaoxu	Liu jiaying